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## Features

- NPT Trench Technology, Positive Temperature Coefficient
- Low Saturation Voltage: V<sub>CE(sat), typ</sub> = 2.0 V
  @ I<sub>C</sub> = 25 A and T<sub>C</sub> = 25°C
- Low Switching Loss: E<sub>off, typ</sub> = 0.96 mJ @ I<sub>C</sub> = 25 A and T<sub>C</sub> = 25°C
- Extremely Enhanced Avalanche Capability

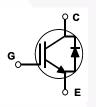
## Applications

Induction Heating, Microwave Oven



# microwave oven.

Description



Using Fairchild's proprietary trench design and advanced NPT

technology, the 1200V NPT IGBT offers superior conduction

and switching performances, high avalanche ruggedness and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating,

## Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V <sub>CES</sub>	Collector-Emitter Voltage		1200	V	
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V	
	Collector Current	@ T <sub>C</sub> = 25°C	50	A	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100°C	25	A	
I <sub>CM (1)</sub>	Pulsed Collector Current		90	A	
	Diode Continuous Forward Current	@ T <sub>C</sub> = 25°C	50	A	
IF	Diode Continuous Forward Current	@ T <sub>C</sub> = 100°C	25	A	
I <sub>FM</sub>	Diode Maximum Forward Current		150	A	
P	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	312	W	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	125	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

## Notes:

(1) Repetitive rating: Pulse width limited by max. junction temperature

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction-to-Case		0.4	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		2.0	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

April 2014

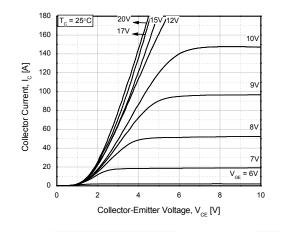
Part Number FGA25N120ANTDTU_F109		Top Mark	Package	Packing Method	Reel Size	Tape Width		Quantity
		FGA25N120ANTDTU	TO-3PN	Tube	N/A			30
Electric	al Characte	ristics of the IC	<b>GBT</b> T <sub>C</sub> = 25	°C unless otherwise note	d			
Symbol	bol Parameter		Tes	t Conditions	Min.	Тур.	Мах	. Unit
Off Charac	teristics							
I <sub>CES</sub>	Collector Cut-Off Current		$V_{CF} = V_{CF}$	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V			3	mA
I <sub>GES</sub>	G-E Leakage Cu	rrent		$V_{GE} = V_{GES}, V_{CE} = 0 V$			± 250	nA
00	4						•	
On Charac V <sub>GE(th)</sub>	G-E Threshold V	/oltage	$l_{c} = 25 \text{ m}$	A, V <sub>CE</sub> = V <sub>GE</sub>	3.5	5.5	7.5	V
· GE(ເກ)			-	$V_{GE} = 15 V$		2.0		V
Var( n	Collector to Emit Saturation Voltage	ollector to Emitter		V <sub>GE</sub> = 15 V, C		2.15		V
		I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V		2.65		V		
Dumanaia C	beresteristics							
Dynamic Characteristics        C <sub>ies</sub> Input Capacitance					3700		pF	
C <sub>oes</sub>		Output Capacitance		V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz		130		pF
C <sub>res</sub>	Reverse Transfe					80		pF
103								· ·
Switching	Characteristics						r –	
t <sub>d(on)</sub>	Turn-On Delay Time Rise Time			-		50		ns
t <sub>r</sub>			_			60		ns
t <sub>d(off)</sub>	Turn-Off Delay T	ime	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 25 A,			190		ns
t <sub>f</sub>	Fall Time		$R_{G} = 10 \Omega$	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 25^{\circ}C$		100		ns
Eon	Turn-On Switchin	ng Loss		.0au, 1 <sub>C</sub> - 25 C		4.1		mJ
E <sub>off</sub>	Turn-Off Switchin	5				0.96		mJ
E <sub>ts</sub>	Total Switching L	.OSS				5.06		mJ
t <sub>d(on)</sub>	Turn-On Delay T	ïme				50		ns
t <sub>r</sub>	Rise Time					60		ns
t <sub>d(off)</sub>	Turn-Off Delay T	ime	V <sub>CC</sub> = 600	V, I <sub>C</sub> = 25 A,		200		ns
t <sub>f</sub>	Fall Time	Fall Time		R <sub>G</sub> = 10Ω, V <sub>GE</sub> = 15 V,		154		ns
E <sub>on</sub>	Turn-On Switchin	-	Inductive L	Inductive Load, T <sub>C</sub> = 125°C		4.3		mJ
E <sub>off</sub>	Turn-Off Switchin	ng Loss				1.5		mJ
E <sub>ts</sub>	Total Switching L	OSS				5.8		mJ
Qg	Total Gate Charg	je				200		nC
Q <sub>ge</sub>	Gate-Emitter Ch	arge		V, I <sub>C</sub> = 25 A,		15		nC
Q <sub>gc</sub>	Gate-Collector C	harge	GE IU	V <sub>GE</sub> = 15 V		100		nC

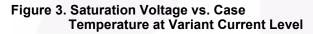
FGA25N120ANTDTU
- 120
0 V, 25 A N
Þ
P
<b>F</b> Trench
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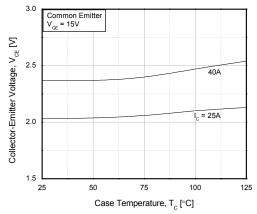
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V <sub>FM</sub> Diode Forward Volta	Diada Farward Valtage	1 - 25 A	T <sub>C</sub> = 25°C		2.0	3.0	v
	Didde Forward Voltage	I <sub>F</sub> = 25 A	T <sub>C</sub> = 125°C		2.1		v
t <sub>rr</sub> Diode Reverse		I <sub>F</sub> = 25 A di <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 25°C		235	350	ns
	Diode Reverse Recovery Time		T <sub>C</sub> = 125°C		300		
1	Diode Peak Reverse Recovery Cur-		$T_{\rm C}$ = 25°C		27	40	A
rr rei	rent		T <sub>C</sub> = 125°C		31		
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25°C		3130	4700	nC
			T <sub>C</sub> = 125°C		4650		

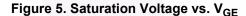
## **Typical Performance Characteristics**

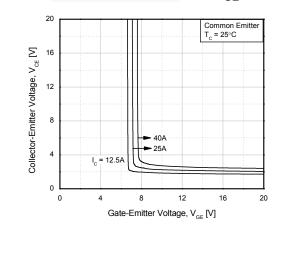
## Figure 1. Typical Output Characteristics











Volta



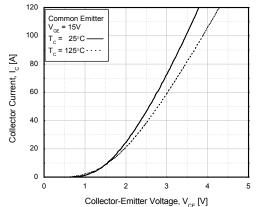


Figure 4. Saturation Voltage vs. V<sub>GE</sub>

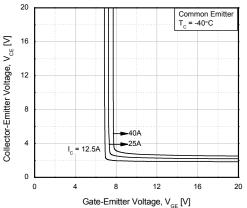
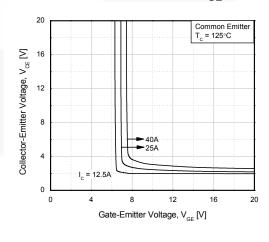


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

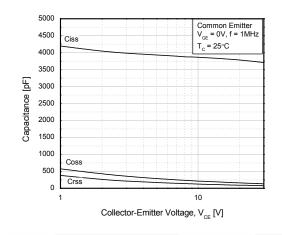


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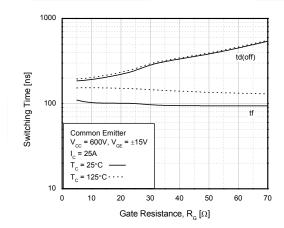


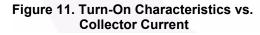
## Typical Performance Characteristics (Continued)

## Figure 7. Capacitance Characteristics









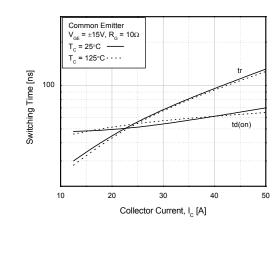
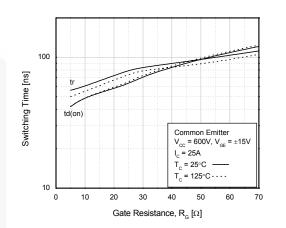
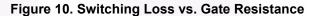
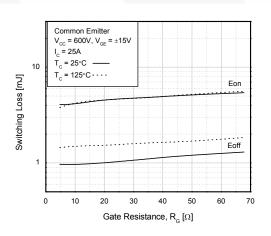
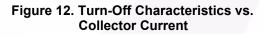


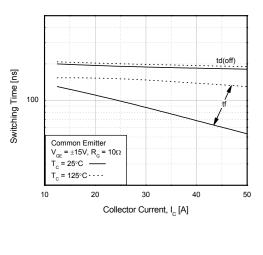
Figure 8. Turn-On Characteristics vs. Gate Resistance

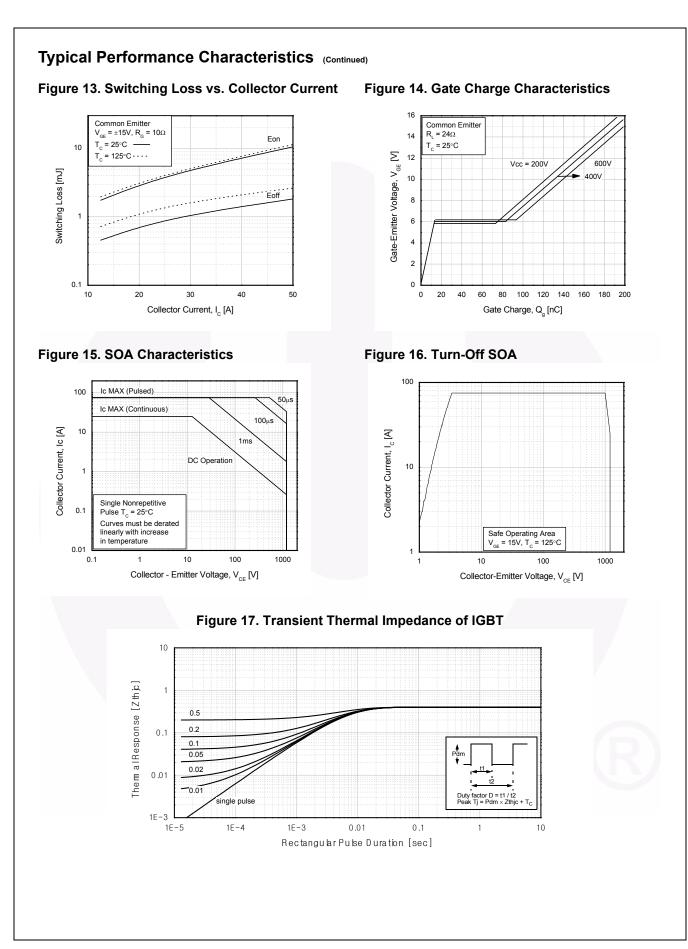










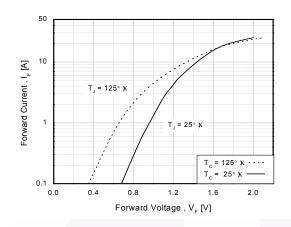


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# FGA25N120ANTDTU — 1200 V, 25 A NPT Trench IGBT

## Typical Performance Characteristics (Continued)

## Figure 18. Forward Characteristics



# $\frac{30}{25}$ $\frac{10}{15}$ $\frac{10}{5}$ $\frac{10}{5$

Forward Current , I<sub>F</sub> [A]

Figure 19. Reverse Recovery Current



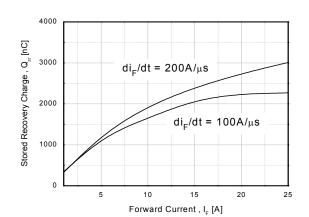
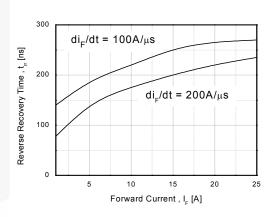
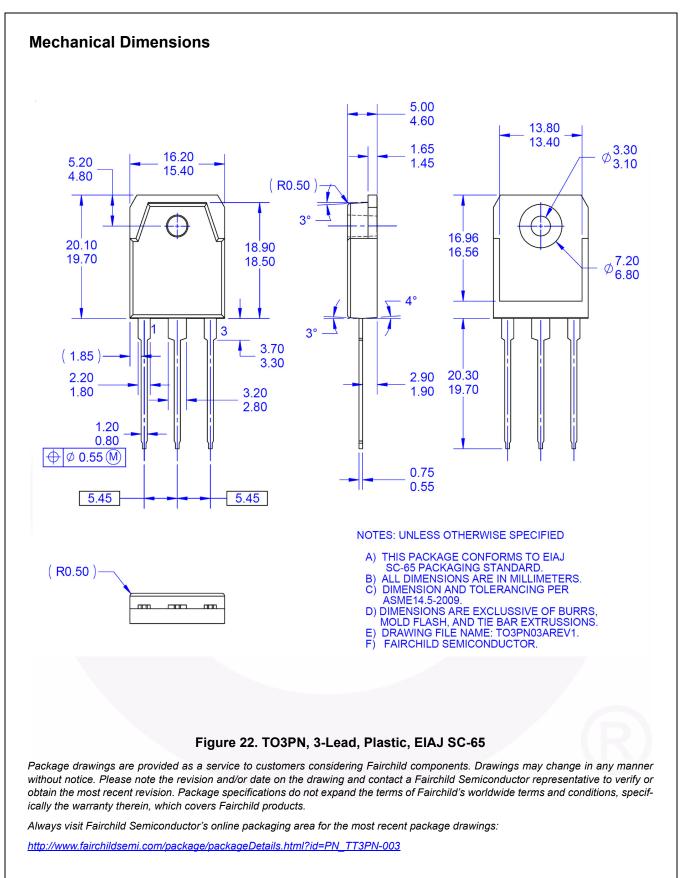


Figure 21. Reverse Recovery Time







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